



◆ DESCRIPTION

The MT1118 series is a Low dropout (LDO) linear regulator. The devices have been optimized for applications where fast transient response and minimum input voltages are critical.

At light loads the typical dropout voltage is 10mV, and at full load the maximum dropout voltage is less than 500mV. The internal over-current protection and thermal protection, makes the device extremely easy to use in a wide range of applications.

◆ FEATURES

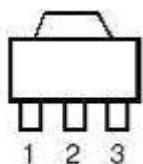
- Low dropout performance
- Output current of 500mA typical
- Thermal shutdown protection
- Fixed 1.5V/ 1.8V/ 2.5V/ 2.8V/ 3.0V/ 3.3V/3.6V output voltages available
- SOT-89, and SOT-23 packages available

◆ APPLICATIONS

- Active SCSI terminators
- Battery chargers
- High efficiency linear regulators
- Wireless communication systems
- Digital camera

◆ PIN CONFIGURATIONS

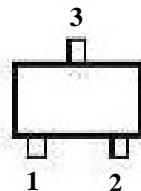
SOT-89 (Top View)



MT11181-X.XJ 1:OUT, 2:GND 3:IN

MT11182-X.XJ 1:GND, 2:IN, 3:OUT

SOT-23 (Top View)



MT11181.X.XS 1:OUT, 2:IN, 3:GND

MT11182-X.XS 1:GND, 2:OUT, 3:IN



◆ ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Maximum	Unit
Input supply voltage	V _{IN}	6	V
Thermal resistance junction to ambient SOT-89	θ _{JA}	180	°C/W
SOT-23		230	°C/W
Junction temperature	T _J	150	°C
Storage temperature range	T _{STG}	-10 to 150	°C
Lead temperature (soldering) 10sec	T _{LEAD}	260	°C

Note:

Exceeding these ratings could cause damage to the device. All voltages are with respect to Ground. Currents are positive into, negative out of the specified terminal.

◆ ORDERING INFORMATION

Device	Package		Vout Volts	T _J (°C)
MT11181-X.XJ	J	SOT-89	X.X_1.5/1.8/2.5/2.8/3.0/3.3/3.6	-40 ~ 125
MT11182-X.XJ				
MT11181-X.XS	S	SOT-23	X.X_1.5/1.8/2.5/2.8/3.0/3.3/3.6	-40 ~ 125
MT11182-X.XS				

◆ POWER DISSIPATION TABLE

Package	θ _{JA} (°C /W)	T _A ≤ 25 °C Power rating(mW)	T _A =70 °C Power rating(mW)	T _A = 85 °C Power rating (mW)
J	180	694	444	361
S	230	543	348	283

Note :

1. Exceeding the maximum allowable power dissipation will result in excessive die temperature, and the regulator will go into Thermal shutdown
2. T_J Junction Temperature Calculation: T_J = T_A + (P_D × θ_{JA})
The θ_{JA} numbers are guidelines for the thermal performance of the device/PC-board system
All of the above assume no ambient airflow
3. θ_{JA}: Thermal Resistance-Junction to Ambient, D_f: Derating factor, P_O: Power consumption.

◆ RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	Operating Conditions			Unit
		Min.	Typ.	Max.	
Input Voltage	V _{IN}	2.8	-	5.5	V
Load Current (with adequate heat sinking)	I _O	5	-	-	mA
Junction temperature	T _J	-	-	125	°C



◆ ELECTRICAL CHARACTERISTICS

Operating Conditions: $V_{IN} = 5V$; $I_{OUT} = 10mA$; $T_J = 25^{\circ}C$, unless otherwise specified. ($C_{OUT} = 2.2\mu F$, $C_{IN} = 2.2\mu F$).

Parameter	Symbol	Test Conditions		Min.	Typ.	Max.	Unit
Output Voltage	V_{OUT}	MT1118-1.5 ($V_{IN} = 2.8V$)		1.455	1.5	1.545	V
		MT1118-1.8 ($V_{IN} = 2.8V$)		1.746	1.8	1.854	V
		MT1118-2.5		2.424	2.5	2.575	V
		MT1118-2.8		2.716	2.8	2.884	V
		MT1118-3.0		2.910	3.0	3.090	V
		MT1118-3.3		3.201	3.3	3.399	V
		MT1118-3.6		3.492	3.6	3.708	V
Line Regulation	V_{SR}	$V_{IN} = (V_{OUT} + 1)V$ to 5.5V		-	1	-	%
Load Regulation (2)	V_{LR}	$V_{IN} = (V_{OUT} + 1)V$	$I_{OUT} = 10\sim 250mA$	-	1	-	%
			$I_{OUT} = 10\sim 500mA$	-	1.5	-	
Ground Current	I_{GND}	$I_{OUT} = 10mA$		-	100	-	uA
Dropout Voltage (3)	V_D	$I_{OUT} = 500mA$		-	0.8	-	V
Current Limit	I_{LIMIT}	$V_{OUT} = 0V$		-	0.6	-	A
Output Voltage Temperature Coefficient	T_c	Note 1		-	50	-	ppm/ $^{\circ}C$,
Thermal Protection	T_{PRO}	Thermal Protection Temperature		-	150	-	$^{\circ}C$,
		Protection Hysterisis		-	20	-	
RMS Output Noise	V_N	$T_A = 25^{\circ}C \mu$ $10Hz \leq f \leq 10kHz$		-	0.003	-	$\% / V_O$
Ripple Rejection Ratio	PSRR	$f = 120Hz$,		-	59	-	dB

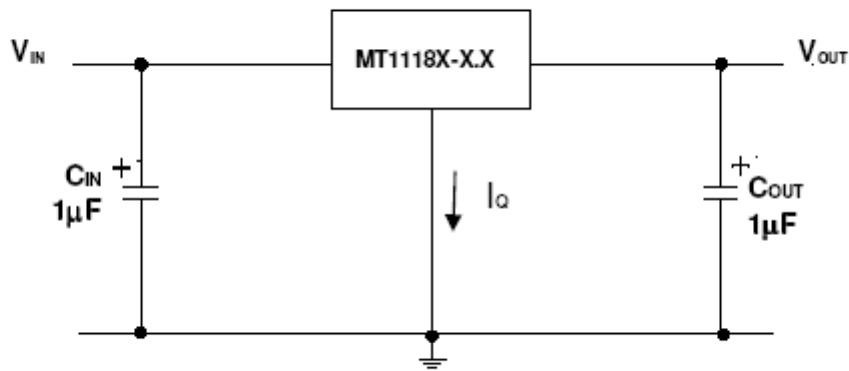
NOTES:

- (1) Output voltage temperature coefficient is the worst case voltage change divided by the total temperature range.
- (2) Regulation is measured at constant junction temperature using low duty cycle pulse testing. Parts are tested for load regulation in the load range from $100\mu A$ to $500mA$. Changes in output voltage due to heating effects are covered by the thermal regulation specification.
- (3) Dropout voltage is defined as the input to output differential at which the output voltage drops 2% below its nominal value measured at 1V differential.



◆ TYPICAL APPLICATIONS

Fixed Voltage Regulator:



◆ APPLICATION NOTE

(1) Output voltage temperature coefficient is the worst case voltage change divided by the total temperature range.

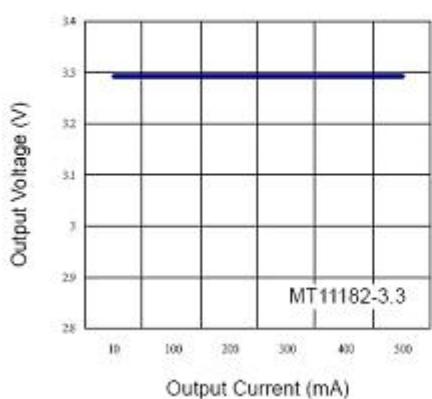


MATRIX MICROTECH CORP.

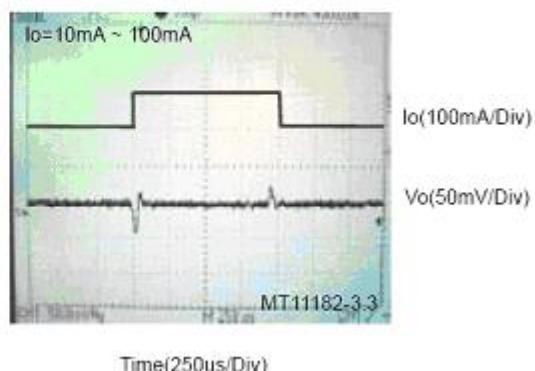
MT1118

500mA LDO Linear Voltage Regulator

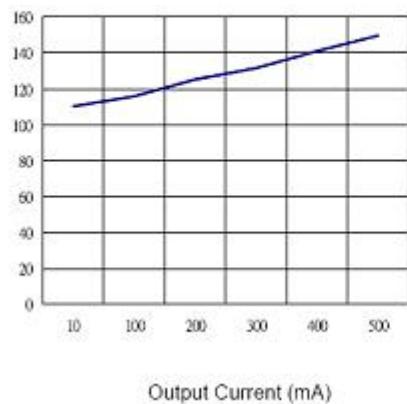
LOAD REGULATION



LOAD TRANSIENT RESPONSE

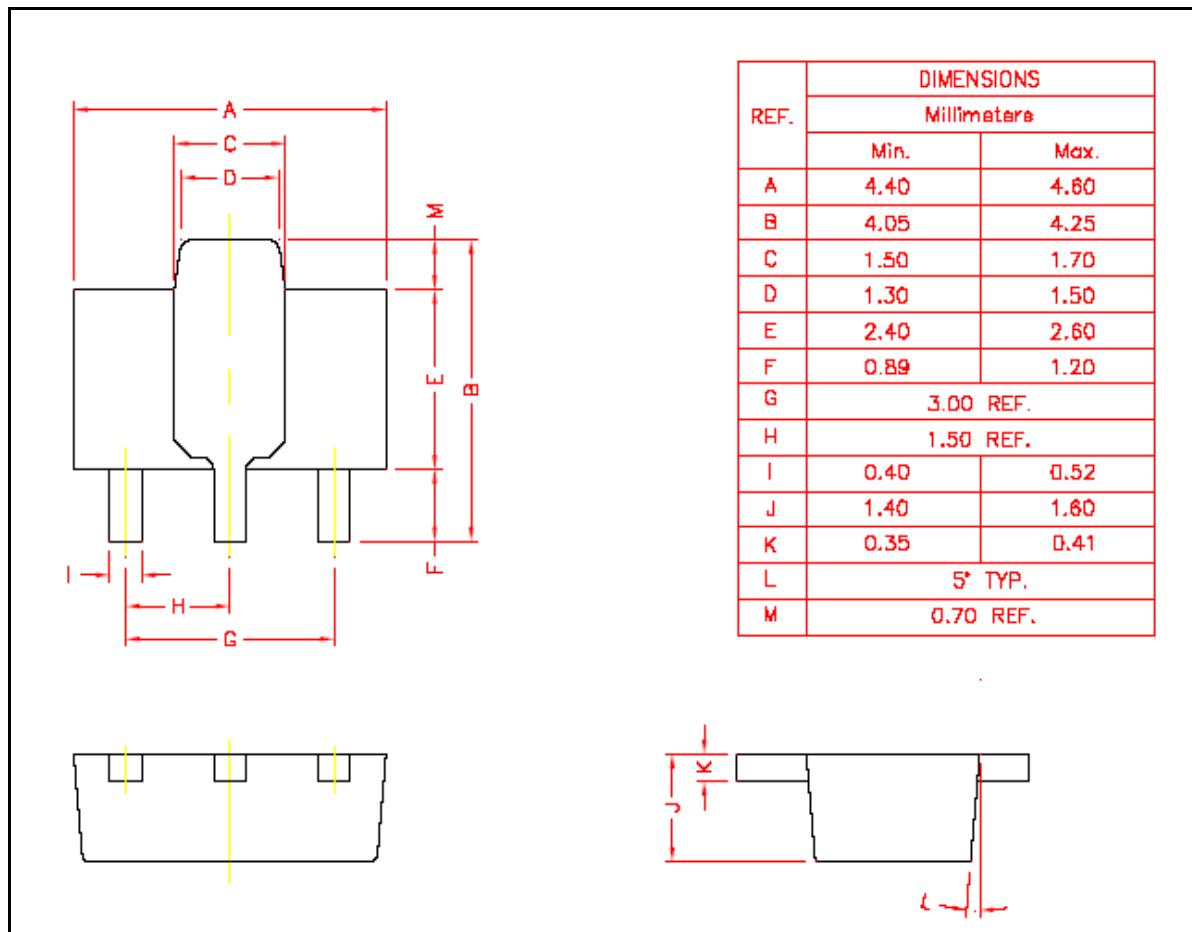


Quiescent Current vs I_{OUT}



**◆ PHYSICAL DIMENSIONS**

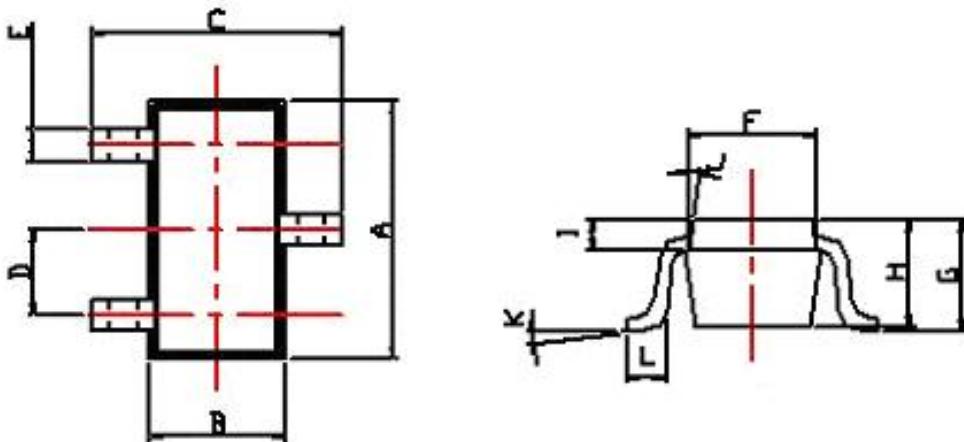
3-Pin surface Mount SOT-89(J)





◆ PHYSICAL DIMENSIONS

3-Pin surface Mount SOT-23(S)



REF.	Millimeter		REF.	Millimeter	
	Min.	Max.		Min.	Max.
A	2.70	3.10	G	0.9	1.4
B	1.20	1.66	H	0.8	1.30
C	2.37	2.90	I	0.25	0.7
D	0.85	1.15	J	$7 \pm 2^\circ$.	
E	$0.350 + 0.15/-0.05$		K	$0 \sim 10^\circ$.	
F	1.07	1.53	L	0.2 (MIN)	